

1.6X1.25mm BI-COLOR SMD CHIP LED LAMP

Part Number: APTB1612ESGC-F01

High Efficiency Red Super Bright Green

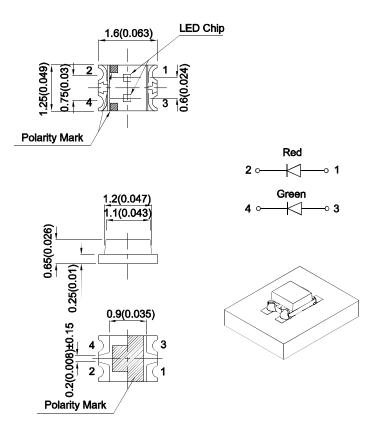
Features

- 1.6mmx1.25mm SMD LED, 0.65mm thickness.
- Bi-color,low power consumption.
- Wide viewing angle.
- Ideal for backlight and indicator.
- Package: 2000pcs / reel.
- Moisture sensitivity level : level 3.
- RoHS compliant.

Descriptions

- The High Efficiency Red source color devices are made with Gallium Arsenide Phosphide on Gallium Phosphide Orange Light Emitting Diode.
- The Super Bright Green source color devices are made with Gallium Phosphide Green Light Emitting Diode.

Package Dimensions





- 1. All dimensions are in millimeters (inches).
 2. Tolerance is ±0.2(0.008") unless otherwise noted.
- 3. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.

4. The device has a single mounting surface. The device must be mounted according to the specifications.

DATE: JUL/11/2016 SPEC NO: DSAF1097 **REV NO: V.12A** PAGE: 1 OF 6 **APPROVED: Wynec CHECKED: Allen Liu** DRAWN: W.Q.Zhong ERP: 1203002009

Selection Guide

Part No.	Emitting Color (Material)	Lens Type	lv (mcd) [2] @ 20mA		Viewing Angle [1]
	- , ,		Min.	Тур.	201/2
APTB1612ESGC-F01	High Efficiency Red (GaAsP/GaP)	Water Clear	8	15	150°
			*3	*7	
	Super Bright Green (GaP)		5	12	
			*5	*12	

Notes:

- 1. 01/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
 2. Luminous intensity / luminous Flux: +/-15%.

 * Luminous intensity value is traceable to CIE127-2007 standards.

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Emitting Color	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	High Efficiency Red Super Bright Green	627 565		nm	I==20mA
λD [1]	Dominant Wavelength	High Efficiency Red Super Bright Green	617 568		nm	I==20mA
Δλ1/2	Spectral Line Half-width	High Efficiency Red Super Bright Green	45 30		nm	I==20mA
С	Capacitance	High Efficiency Red Super Bright Green	15 15		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	High Efficiency Red Super Bright Green	2 2.2	2.5 2.5	V	I==20mA
lR	Reverse Current	High Efficiency Red Super Bright Green		10 10	uA	V _R = 5V

Notes:

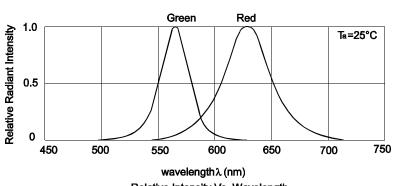
- 1. Wavelength: +/-1nm.
- 2. Forward Voltage: +/-0.1V.
- 3. Wavelength value is traceable to CIE127-2007 standards.
- 4. Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

Absolute Maximum Ratings at TA=25°C

Parameter	High Efficiency Red	Super Bright Green	Units		
Power dissipation	75	62.5	mW		
DC Forward Current	30	25	mA		
Peak Forward Current [1]	160	140	mA		
Reverse Voltage		V			
Operating Temperature	-40°C To +85°C				
Storage Temperature	-40°C To +85°C				

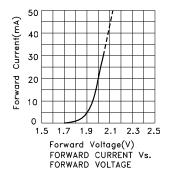
- 1. 1/10 Duty Cycle, 0.1ms Pulse Width.
- 2. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity - Ref JEDEC/JESD625-A and JEDEC/J-STD-033.

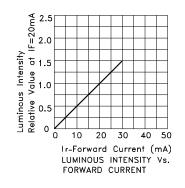
SPEC NO: DSAF1097 **REV NO: V.12A** DATE: JUL/11/2016 PAGE: 2 OF 6 APPROVED: Wynec **CHECKED: Allen Liu** DRAWN: W.Q.Zhong ERP: 1203002009

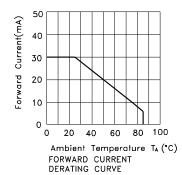


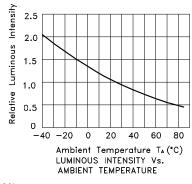
Relative Intensity Vs. Wavelength

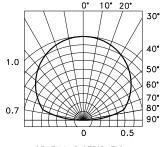
APTB1612ESGC-F01 **High Efficiency Red**









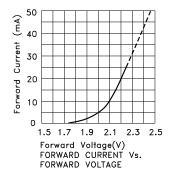


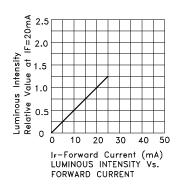
SPATIAL DISTRIBUTION

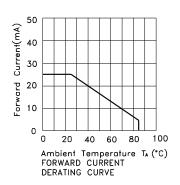
SPEC NO: DSAF1097 APPROVED: Wynec

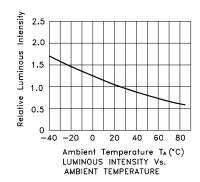
REV NO: V.12A CHECKED: Allen Liu DATE: JUL/11/2016 DRAWN: W.Q.Zhong PAGE: 3 OF 6 ERP: 1203002009

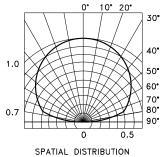
Super Bright Green









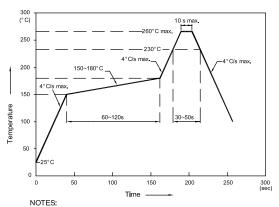


SPEC NO: DSAF1097 APPROVED: Wynec REV NO: V.12A CHECKED: Allen Liu DATE: JUL/11/2016 DRAWN: W.Q.Zhong PAGE: 4 OF 6 ERP: 1203002009

APTB1612ESGC-F01

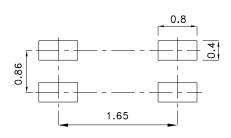
Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.

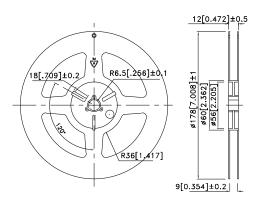


- 1. We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.
- 2.Don't cause stress to the epoxy resin while it is exposed
- to high temperature.
 3.Number of reflow process shall be 2 times or less.

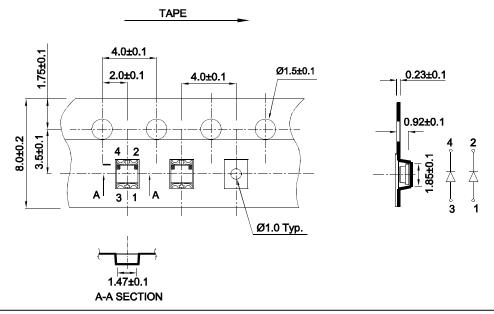
Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)



Reel Dimension



Tape Dimensions

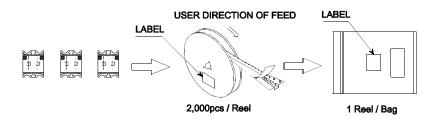


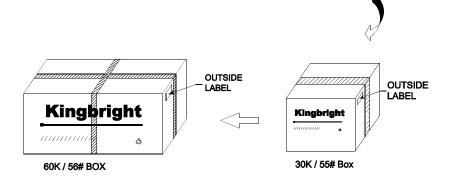
SPEC NO: DSAF1097 APPROVED: Wynec REV NO: V.12A CHECKED: Allen Liu DATE: JUL/11/2016 DRAWN: W.Q.Zhong PAGE: 5 OF 6 ERP: 1203002009

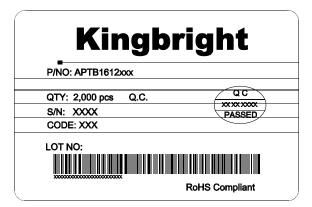


PACKING & LABEL SPECIFICATIONS

APTB1612ESGC-F01







Terms and conditions for the usage of this document

- 1. The information included in this document reflects representative usage scenarios and is intended for technical reference only.
- 2. The part number, type, and specifications mentioned in this document are subject to future change and improvement without notice. Before production usage customer should refer to the latest datasheet for the updated specifications.
- 3. When using the products referenced in this document, please make sure the product is being operated within the environmental and electrical limits specified in the datasheet. If customer usage exceeds the specified limits, Kingbright will not be responsible for any subsequent issues.
- 4. The information in this document applies to typical usage in consumer electronics applications. If customer's application has special reliability requirements or have life-threatening liabilities, such as automotive or medical usage, please consult with Kingbright representative for further assistance.
- 5. The contents and information of this document may not be reproduced or re-transmitted without permission by Kingbright.
- 6. All design applications should refer to Kingbright application notes available at http://www.KingbrightUSA.com/ApplicationNotes

SPEC NO: DSAF1097 **REV NO: V.12A DATE: JUL/11/2016** PAGE: 6 OF 6 **APPROVED: Wynec CHECKED: Allen Liu** DRAWN: W.Q.Zhong ERP: 1203002009